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Docket No.: M1071.1887
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Kenichi Hamanaka et al.

Application No.: 10/735,891

Confirmation No.: 5697

Filed: December 16, 2003

Art Unit: Not Yet Assigned

For: ADHESIVE RESIN COMPOSITION AND
METHOD OF PRODUCING THE SAME,
AND CHIP COIL COMPONENT

Examiner: Not Yet Assigned

STATUS INQUIRY

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

It is respectfully requested that the attorney named below be advised of the status of the above-identified application. Please advise us of when we might expect to receive an Office Action from the Patent and Trademark Office.

Dated: June 16, 2005

Respectfully submitted,

By Edward A. Meilman
Edward A. Meilman

Registration No.: 24,735
DICKSTEIN SHAPIRO MORIN &
OSHINSKY LLP
1177 Avenue of the Americas
41st Floor
New York, New York 10036-2714
(212) 835-1400
Attorney for Applicant